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(12) **United States Design Patent**
Lin

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(54) **PAIR OF EARBUDS**

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(**) Term: **15 Years**

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(52) **U.S. Cl.**
USPC **D14/223**

(58) **Field of Classification Search**
USPC D14/223, 205; D24/174; 128/864, 865, 128/866; 381/380, 381, 328, 322; D13/108; 455/90.3, 575.1, 569.1
CPC H04R 1/10; H04R 25/00; H04R 25/02; H04R 1/1066; H04R 1/1016; H04R 5/033; H04R 5/0335; H04R 1/105; H04R 1/1058; H04R 1/1083
See application file for complete search history.

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Primary Examiner — Paula Allen Greene

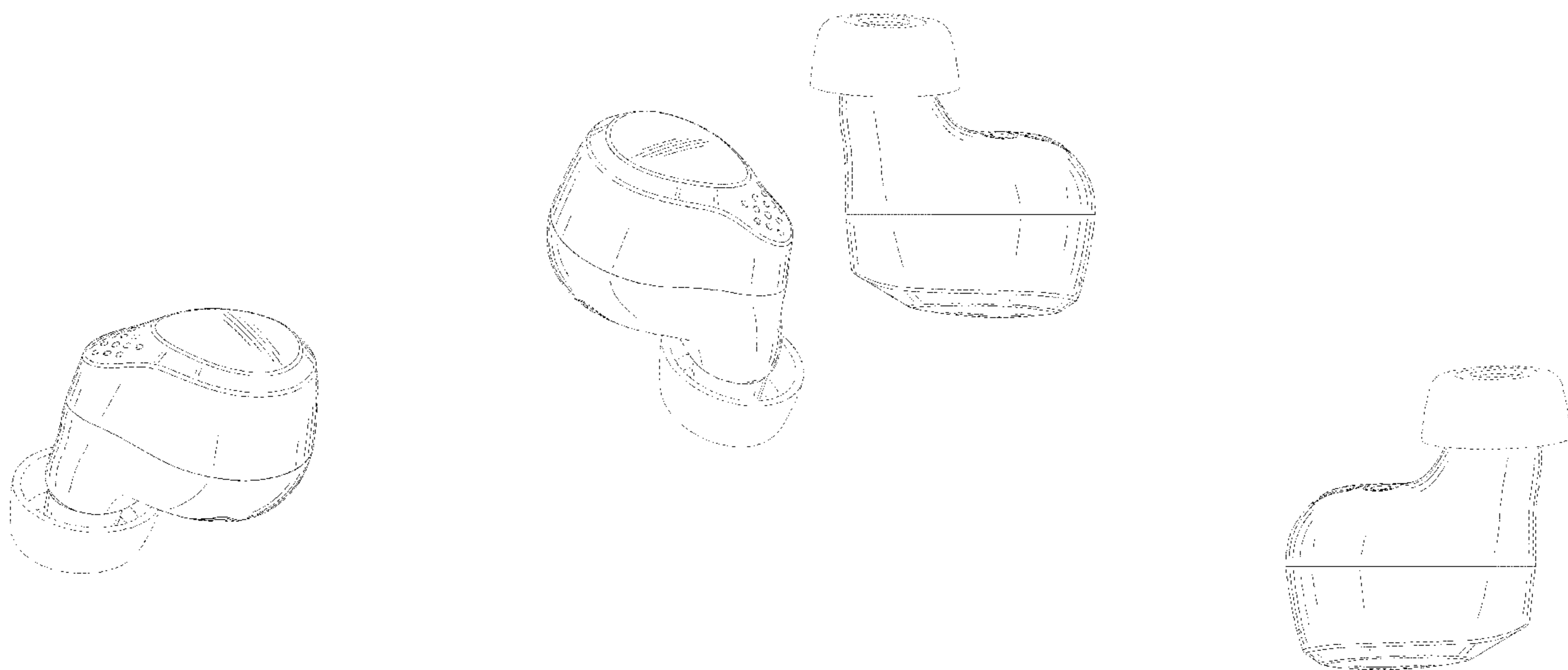
(57) **CLAIM**

The ornamental design for an pair of earbuds, as shown and described.

DESCRIPTION

FIG. 1 is a perspective view of an pair of earbuds showing my new design;
 FIG. 2 is another perspective view thereof;
 FIG. 3 is a front elevation view thereof;
 FIG. 4 is a back elevation view thereof;
 FIG. 5 is a left side view thereof;
 FIG. 6 is a right side view thereof;
 FIG. 7 is a top plan view thereof; and,
 FIG. 8 is a bottom plan view thereof.
 The broken lines in the drawing depict environmental subject matter only and form no part of the claimed design.

1 Claim, 8 Drawing Sheets



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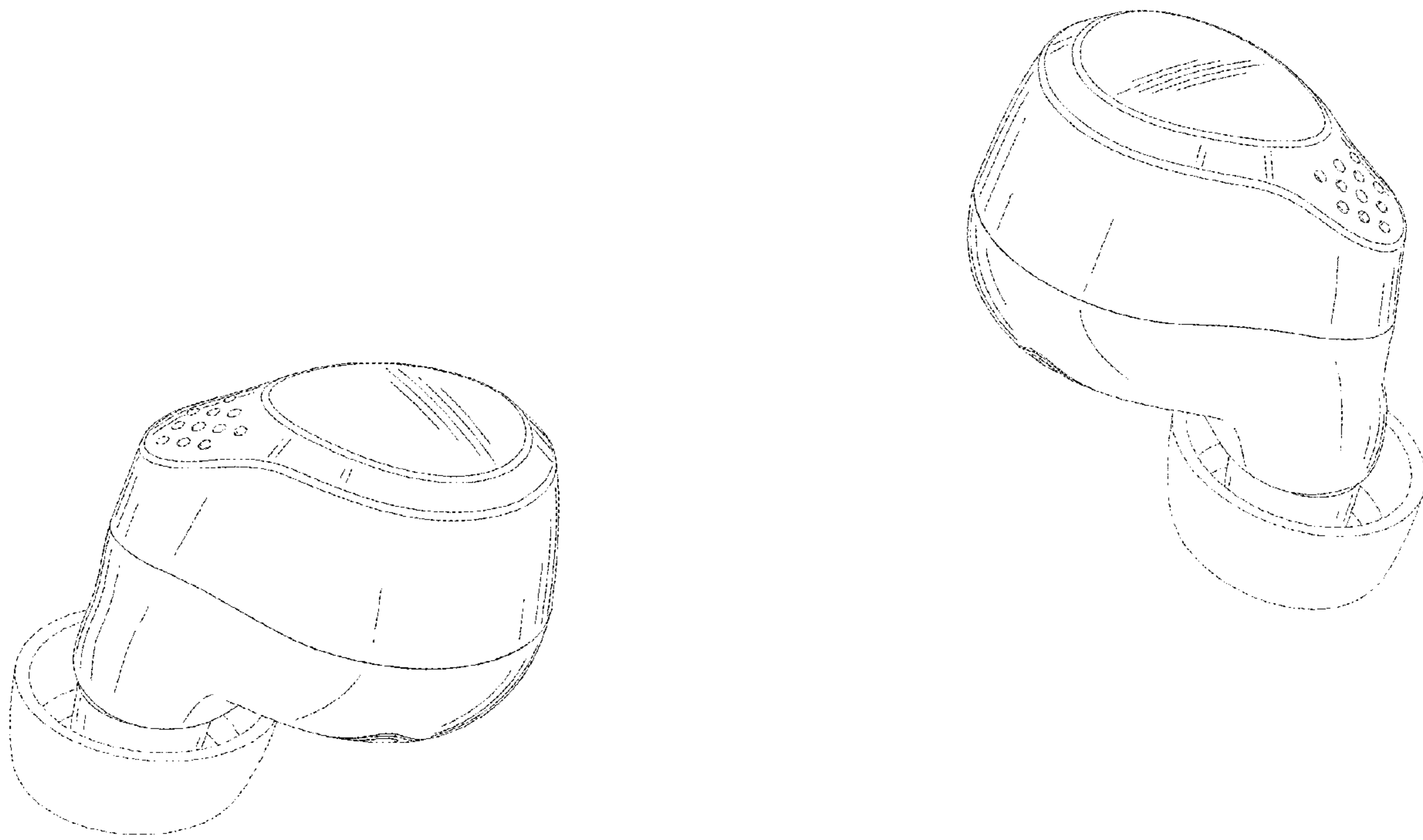


FIG. 1

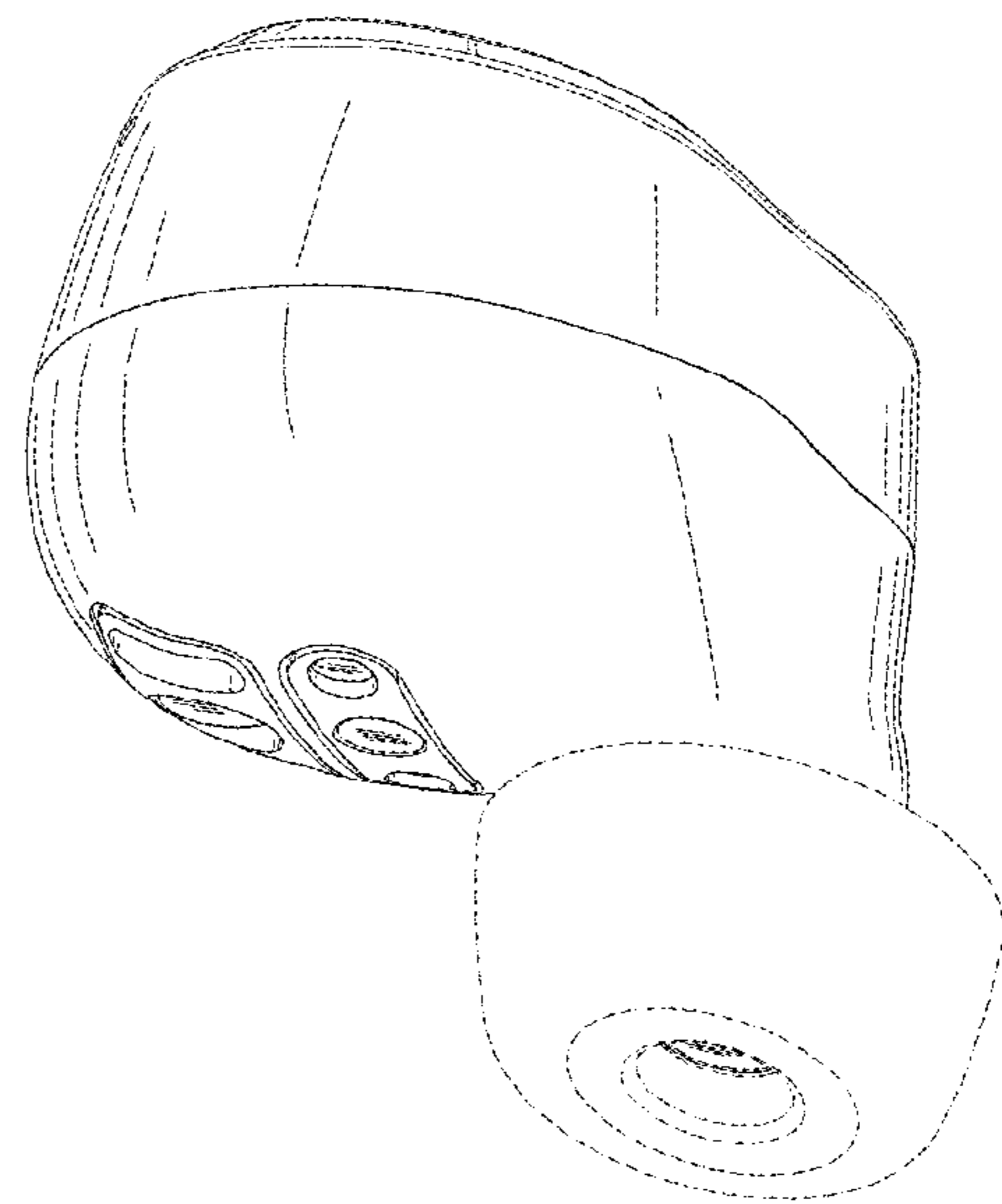
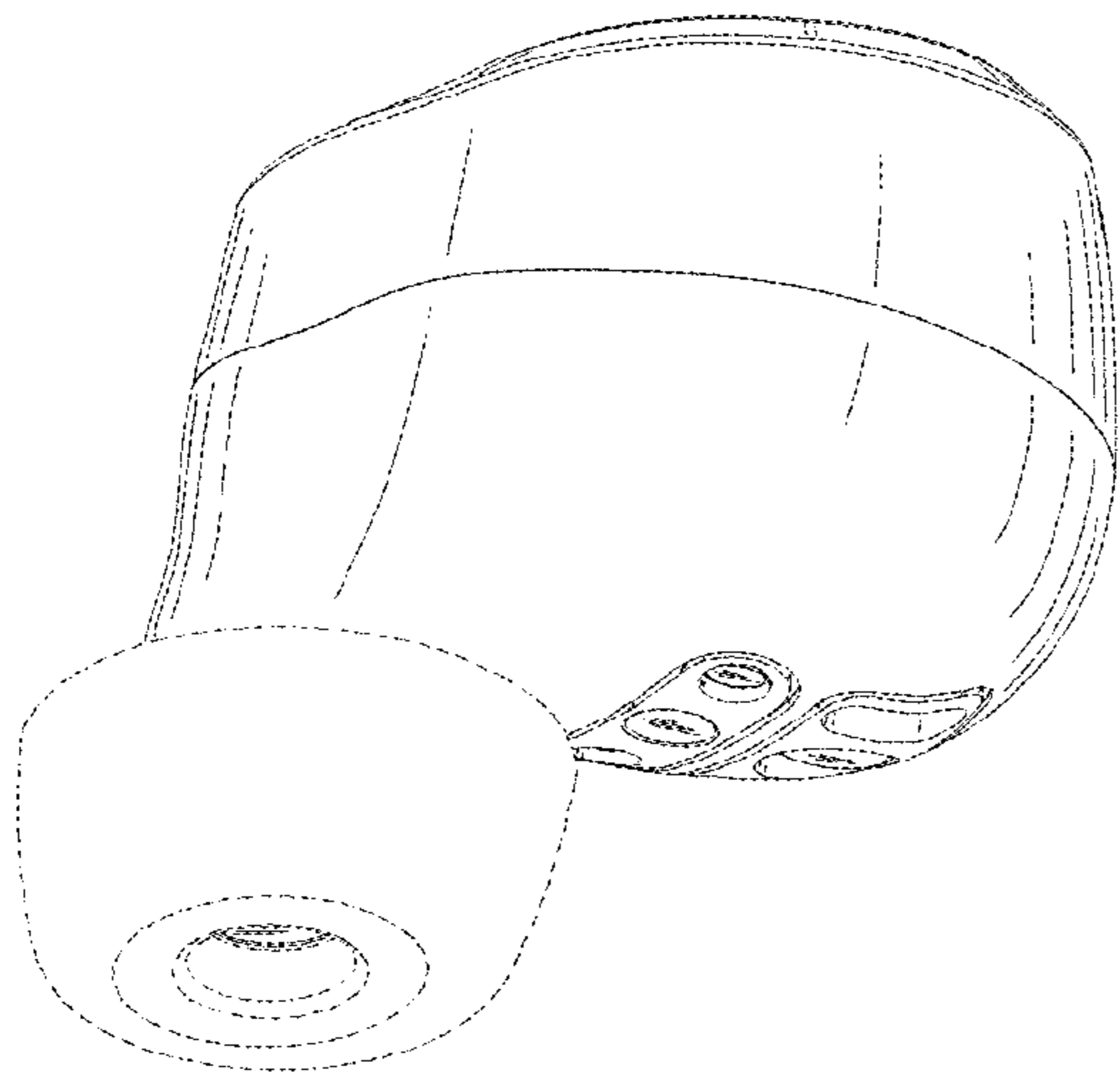


FIG. 2

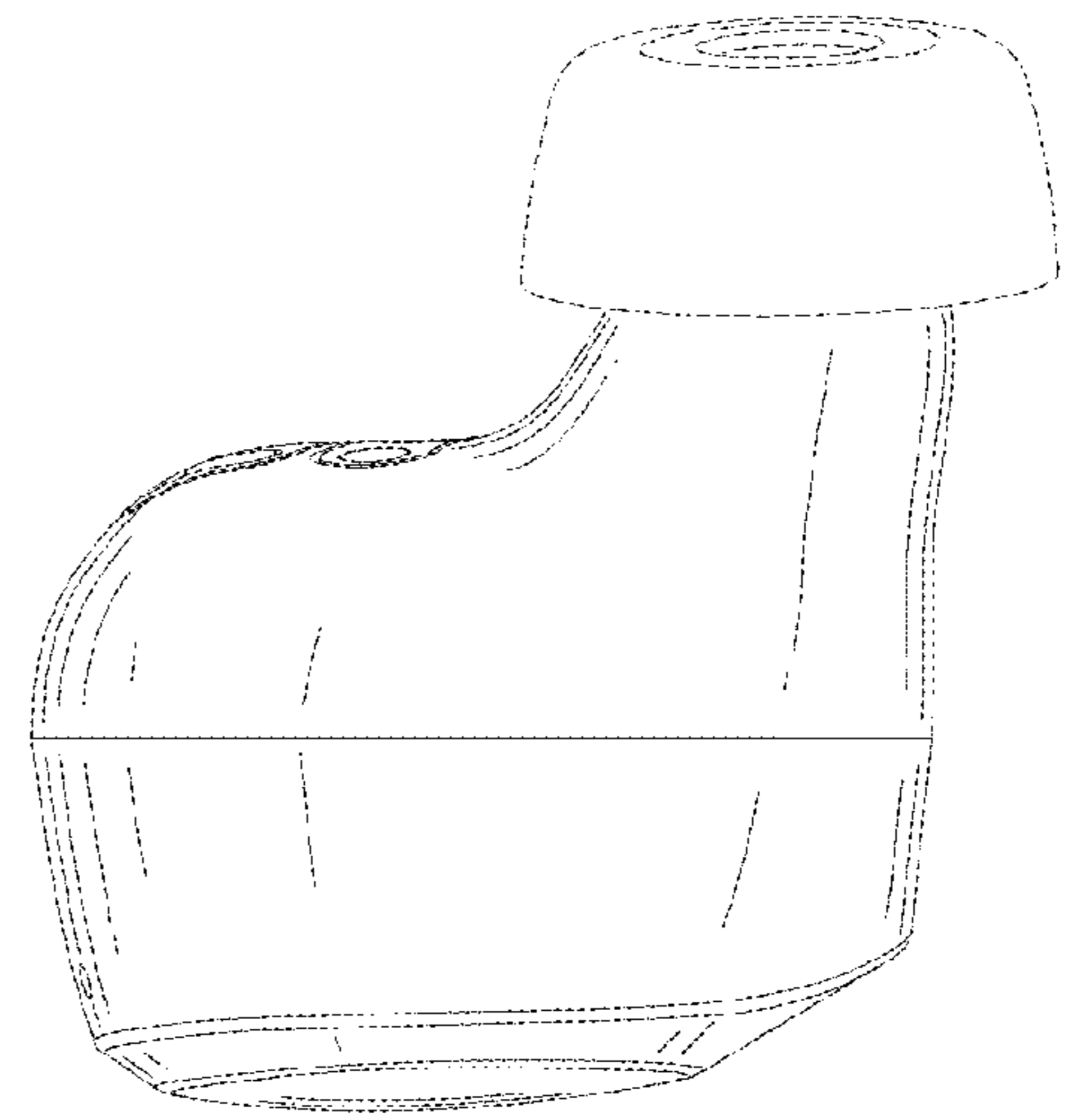
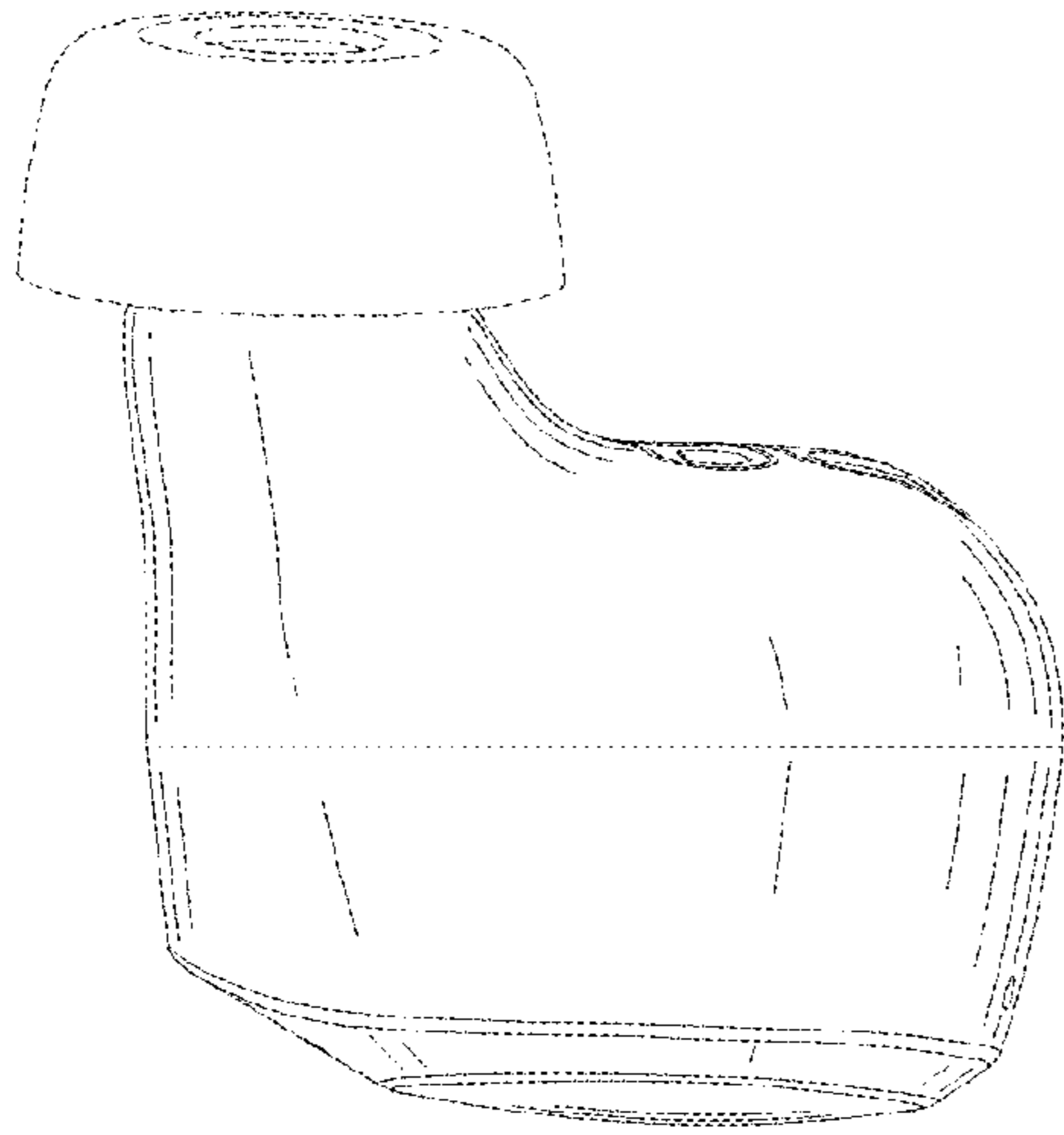


FIG. 3

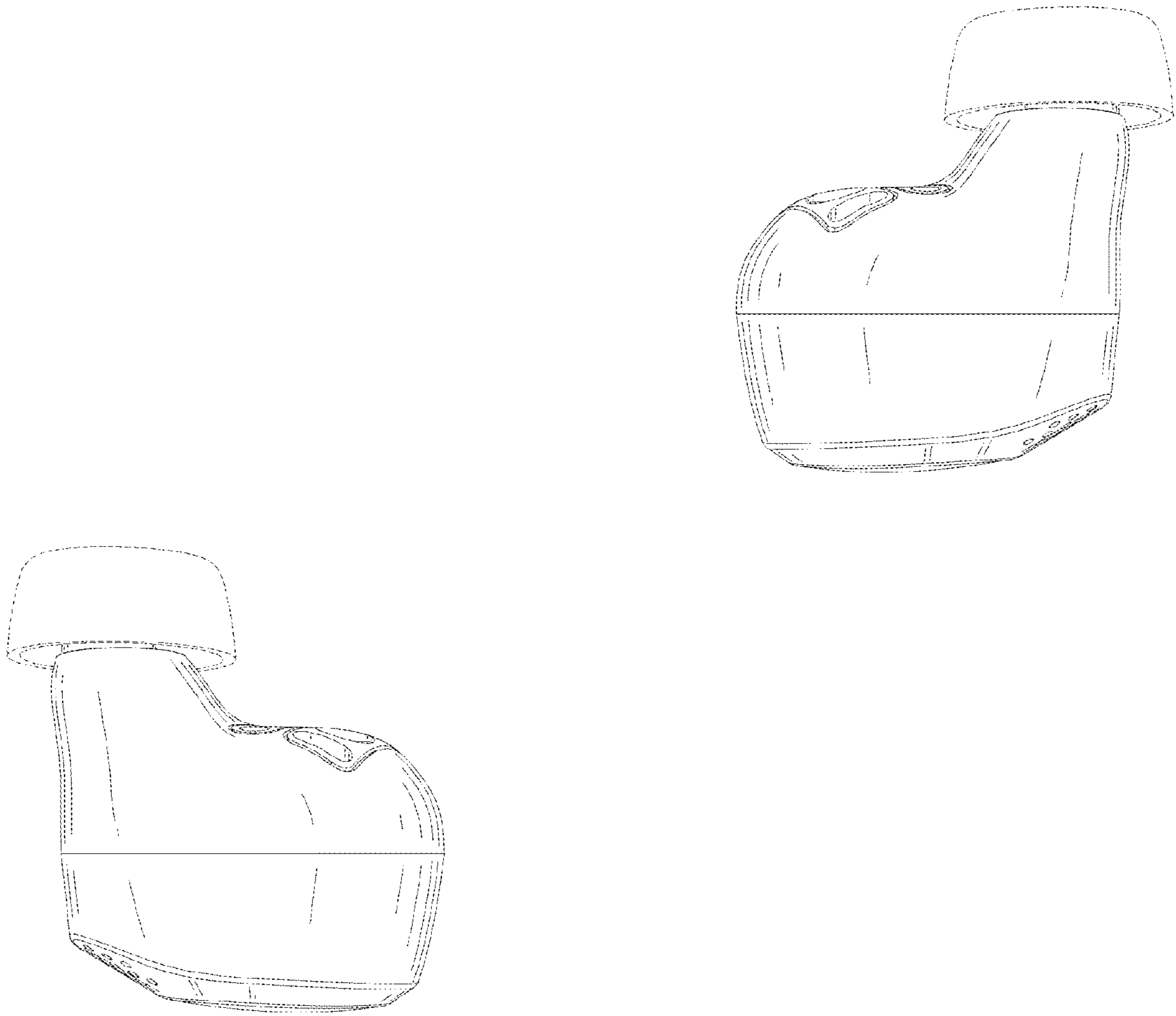


FIG. 4

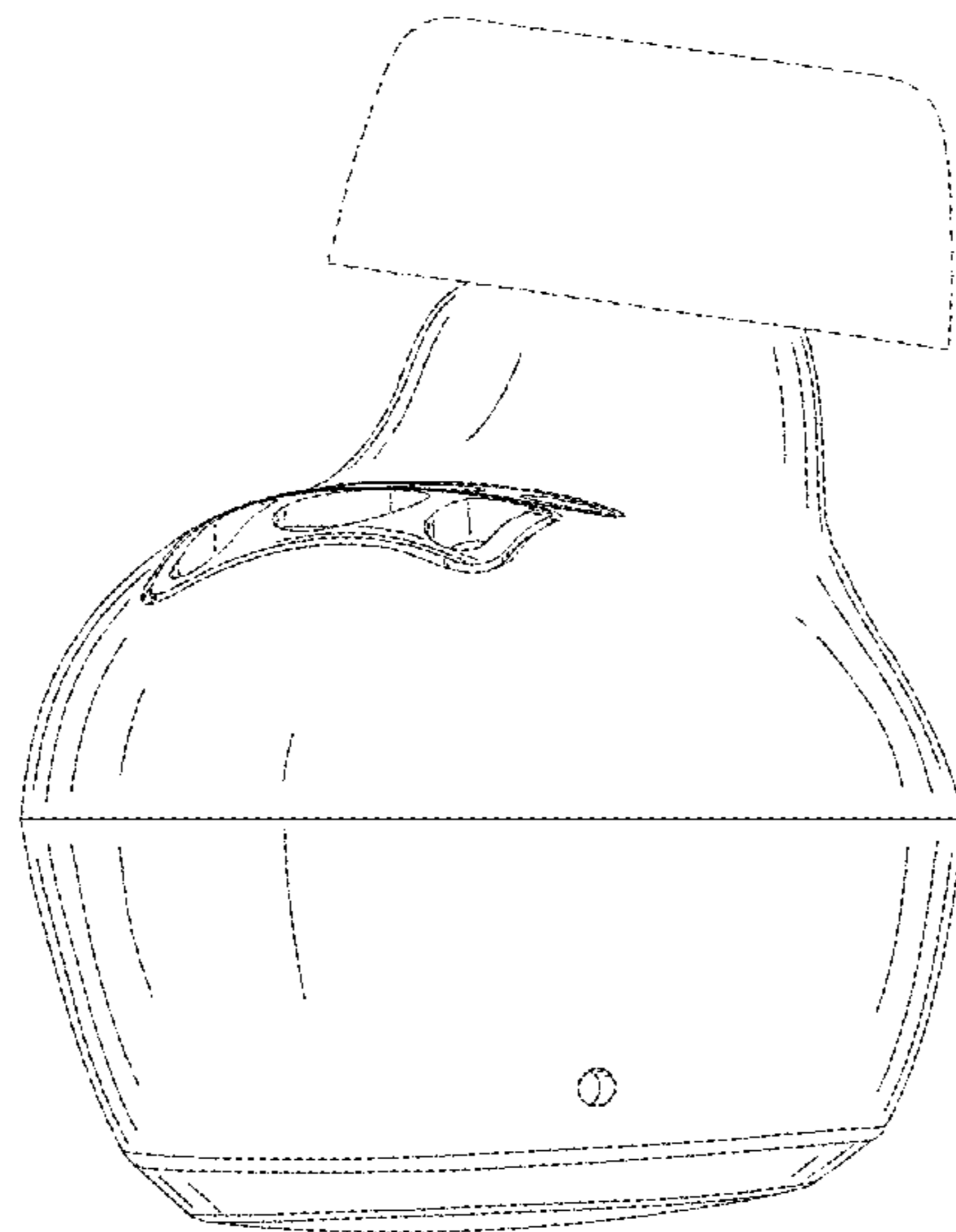
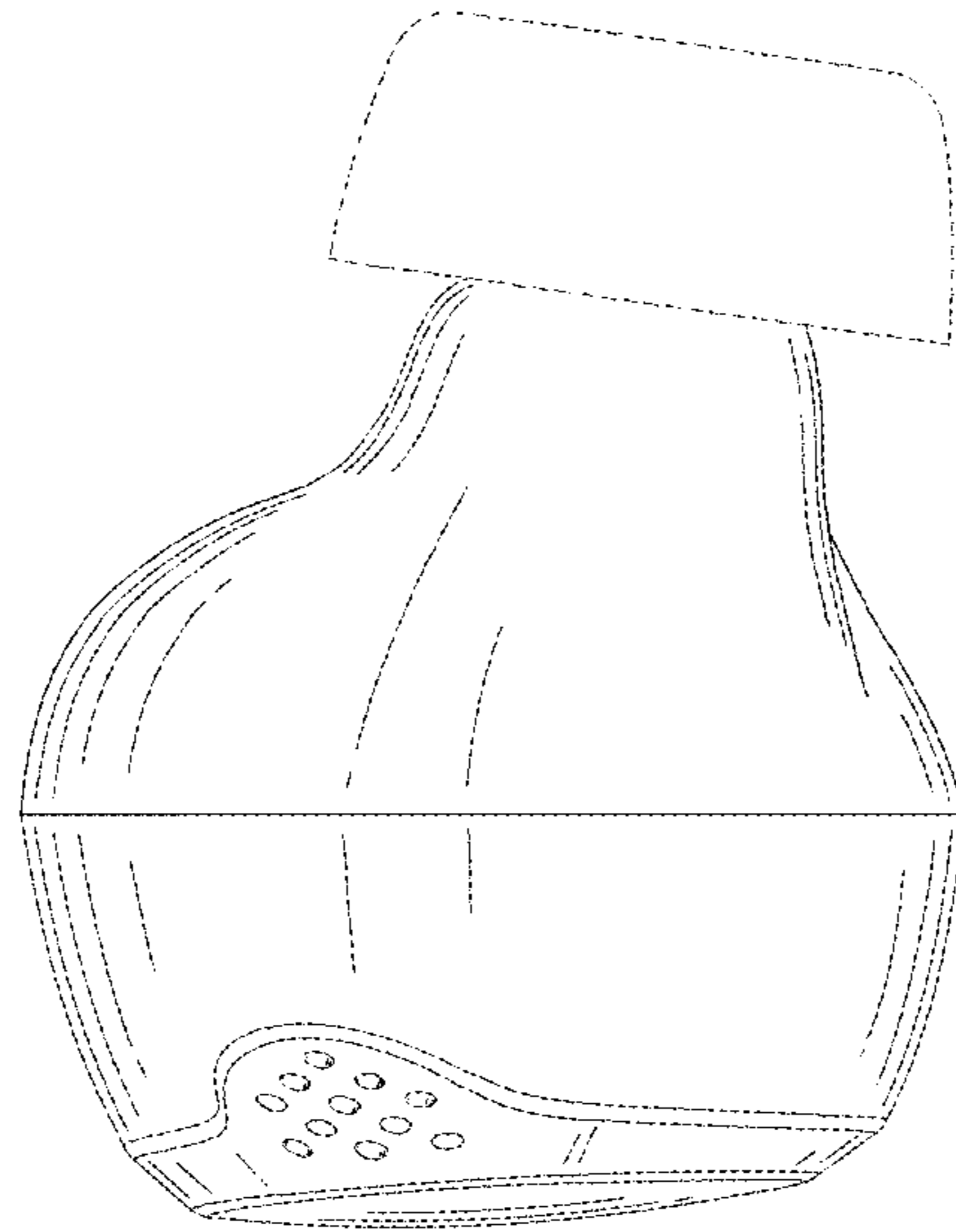


FIG. 5

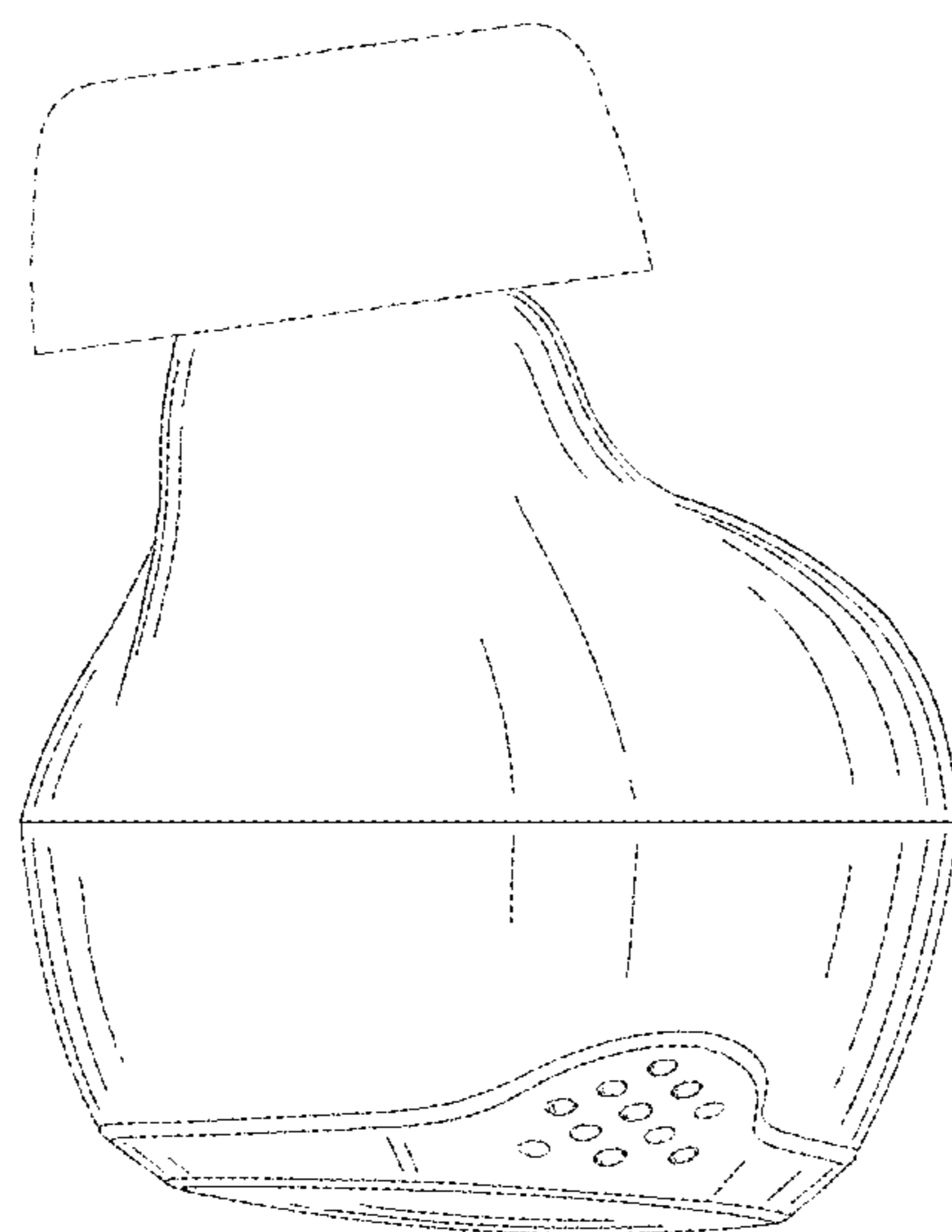
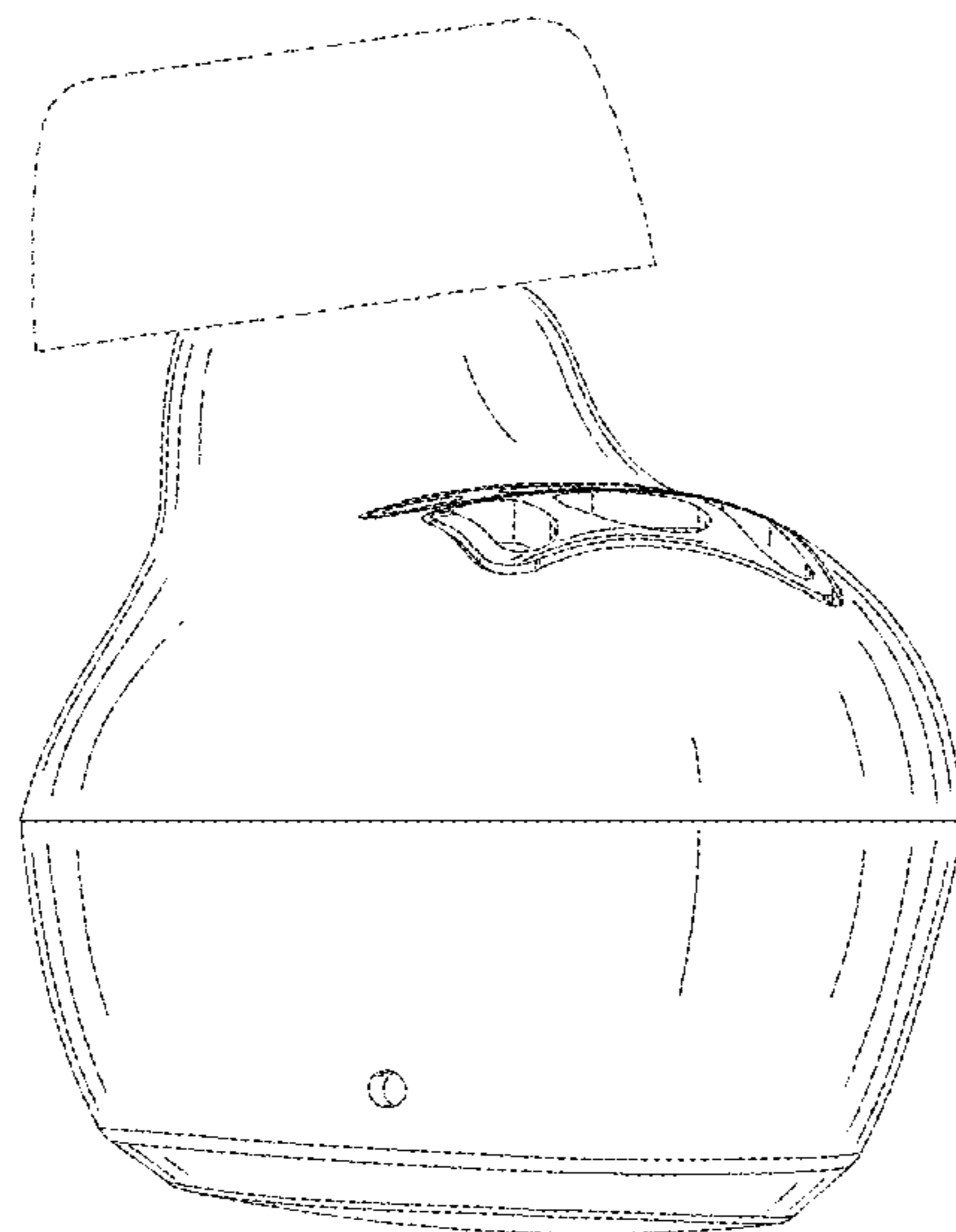


FIG. 6

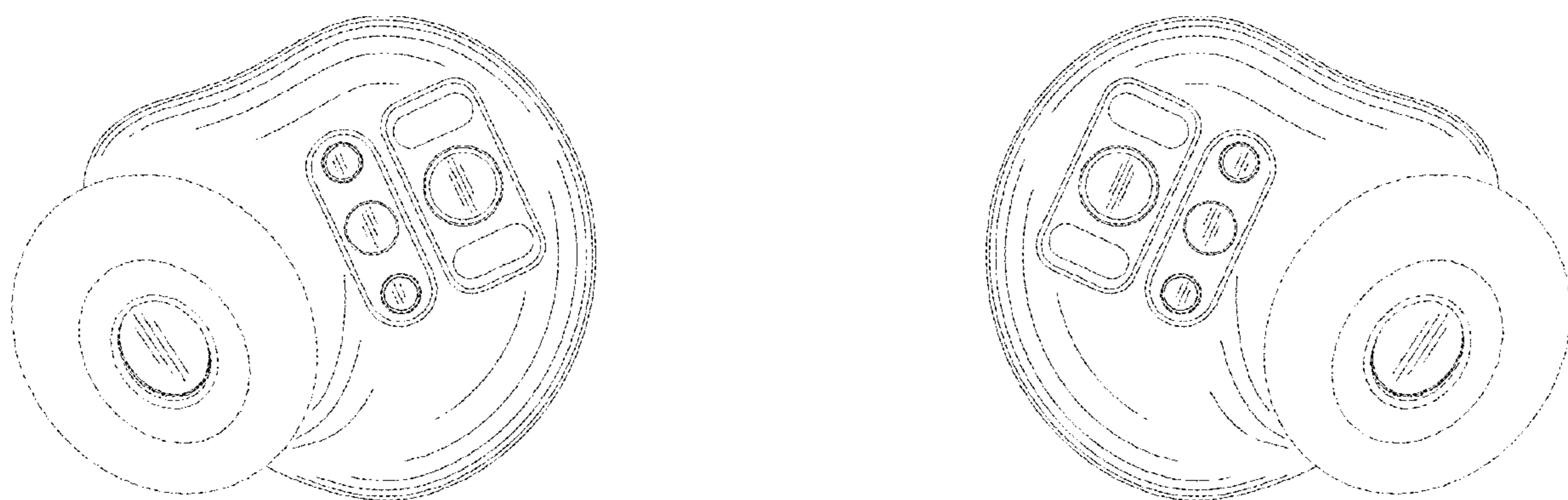


FIG. 7

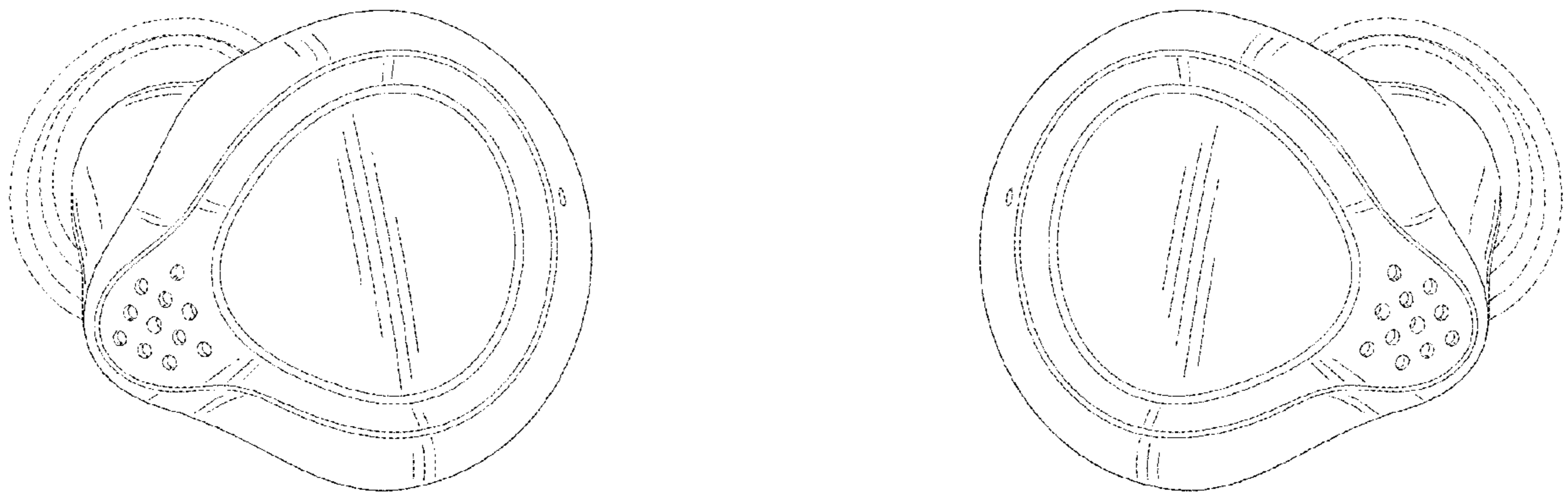


FIG. 8